

Declaration of changes from 5002J to 5002E

● SOFTWARE MODIFICATIONS:

- Protocol Stack changes: No
- MMS/STK/USAT/USIM changes: No
- DM/SUPL/VT/FUMO/SWP/HCI: No
- Other changes detailed:

● HARDWARE MODIFICATIONS:

- Band changes: No
- PCB Layout changes: No
- Main components changes:

	Antenna	Base Band	Transceiver	ASM	Power Amplifier	Tx SAW Filter	Rx SAW Filter	Duplexer
GSM850	NO	NO	NO	NO	NO	NO	NO	NO
GSM900	NO	NO	NO	NO	NO	NO	NO	NO
GSM1800	NO	NO	NO	NO	NO	NO	NO	NO
GSM1900	NO	NO	NO	NO	NO	NO	NO	NO
UMTS2100	NO	NO	NO	NO	NO	NO	NO	NO
UMTS1900	NO	NO	NO	NO	NO	NO	NO	NO
UMTS1700	NO	NO	NO	NO	NO	NO	NO	NO
UMTS900	NO	NO	NO	NO	NO	NO	NO	NO
UMTS850	NO	NO	NO	NO	NO	NO	NO	NO
LTE 2	NO	NO	NO	NO	NO	NO	NO	NO
LTE 3	NO	NO	NO	NO	NO	NO	NO	NO
LTE 4	NO	NO	NO	NO	NO	NO	NO	NO
LTE 5	NO	NO	NO	NO	NO	NO	NO	NO
LTE 7	NO	NO	NO	NO	NO	NO	NO	NO
LTE 8	NO	NO	NO	NO	NO	NO	NO	NO
LTE 13	NO	NO	NO	NO	NO	NO	NO	NO
LTE 17	NO	NO	NO	NO	NO	NO	NO	NO
LTE 28	NO	NO	NO	NO	NO	NO	NO	NO
LTE 66	NO	NO	NO	NO	NO	NO	NO	NO
Bluetooth	NO	NO	NO	NO	NO	NO	NO	NO
WiFi	NO	NO	NO	NO	NO	NO	NO	NO

- FM changes: No
- Other components changes:
LCD/ Speaker/ Camera/ Vibrator changes: NO
- Other changes detailed:
Memory changed from 16+2 to 32+2, and memory chip is pin to pin compatible.

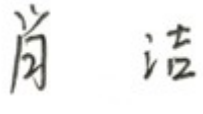
● MECHANICAL MODIFICATIONS:

- Use new metal front/back cover or keypad: No

- Mechanical shell changes:
 - Whole size of EUT: No
 - Distance of Ear reference point to bottom of handset: No
 - Other trinkets to change the surface of handset: No
- Other changes detailed:

APPROVED BY:

Project Manager: 肖洁

Signature: 

Date: 2020/6/15